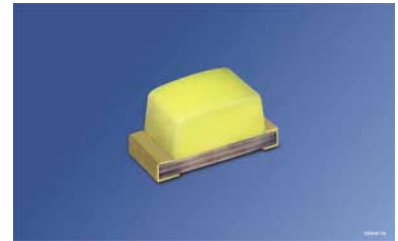


# Hyper CHIPLED Hyper-Bright LED

## LW Q18S



### Besondere Merkmale

- **Gehäusotyp:** SMT Gehäuse 0603
- **Besonderheit des Bauteils:** kleinste Bauform 1,6 x 0,8 x 0,6 mm (LxBxH)
- **Farbort:** x = 0,35, y = 0,34 nach CIE 1931 (weiß)
- **Typische Farbtemperatur:** 4770 K
- **Farbwiedergabeindex:** 80
- **Abstrahlwinkel:** extrem breite Abstrahlcharakteristik (160°)
- **Technologie:** InGaN
- **optischer Wirkungsgrad:** 4 lm/W
- **Gruppierungsparameter:** Lichtstärke, Farbort
- **Verarbeitungsmethode:** für alle SMT-Bestücktechniken geeignet
- **Lötmethode:** IR Reflow Löten
- **Vorbehandlung:** nach JEDEC Level 2
- **Gurtung:** 8 mm Gurt mit 4000/Rolle, ø180 mm
- **ESD-Festigkeit:** ESD-sicher bis 2 kV nach EOS/ESD-5.1-1993

### Anwendungen

- flache Hinterleuchtung (LCD, Handy, Schalter, Display)
- Spielsachen

### Features

- **package:** SMT package 0603
- **feature of the device:** smallest package 1.6 x 0.8 x 0.6 mm (LxWxH)
- **color coordinates:** x = 0.35, y = 0.34 acc. to CIE 1931 (white)
- **typ. color temperature:** 4770 K
- **color reproduction index:** 80
- **viewing angle:** extremely wide (160°)
- **technology:** InGaN
- **optical efficiency:** 4 lm/W
- **grouping parameter:** luminous intensity, color coordinates
- **assembly methods:** suitable for all SMT assembly methods
- **soldering methods:** IR reflow soldering
- **preconditioning:** acc. to JEDEC Level 2
- **taping:** 8 mm tape with 4000/reel, ø180 mm
- **ESD-withstand voltage:** up to 2 kV acc. to EOS/ESD-5.1-1993

### Applications

- flat backlighting (LCD, cellular phones, switches, displays)
- toys

Typ	Emissions- farbe	Farbe der Lichtaustritts- fläche	Lichtstärke		Lichtstrom	Bestellnummer
Type	Color of Emission	Color of the Light Emitting Area	Luminous Intensity $I_F = 6 \text{ mA}$ $I_V \text{ (mcd)}$		Luminous Flux $I_F = 6 \text{ mA}$ $\Phi_V \text{ (lm)}$	Ordering Code
			min.	typ.		
LW Q18S-KM-A2B2	white	colored diffused	7.1	28.0	115 (typ.)	Q62702P5407

Helligkeitswerte werden mit einer Stromeinprägedauer von 25 ms und einer Genauigkeit von  $\pm 11 \%$  ermittelt.  
Luminous intensity is tested at a current pulse duration of 25 ms and a tolerance of  $\pm 11 \%$ .

*Anm.: Farbselektiert nach Farbortgruppen, Lieferung in Einzelgruppen (siehe Seite 5)*

*Die Standardlieferform von Serientypen beinhaltet alle Gruppen. Einzelne Gruppen sind nicht erhältlich.*

*In einer Verpackungseinheit / Gurt ist immer nur eine Gruppe enthalten.*

*Note: Color selection acc. to chromaticity coordinate groups, delivery in single groups (see page 5)*

*The standard shipping format for serial types includes all groups. Individual groups are not available.*

*No packing unit / tape ever contains more than one luminous intensity group.*

**Grenzwerte**  
**Maximum Ratings**

Bezeichnung Parameter	Symbol Symbol	Wert Value	Einheit Unit
Betriebstemperatur Operating temperature range	$T_{op}$	- 30 ... + 85	°C
Lagertemperatur Storage temperature range	$T_{stg}$	- 40 ... + 85	°C
Sperrschichttemperatur Junction temperature	$T_j$	+ 95	°C
Durchlassstrom Forward current	$I_F$	15	mA
Stoßstrom Surge current $t = 10 \mu s, D = 0.1$	$I_{FM}$	0.1	A
Sperrspannung <sup>1)</sup> Reverse voltage	$V_R$	5	V
Leistungsaufnahme Power consumption	$P_{tot}$	60	mW
Wärmewiderstand Thermal resistance Sperrschicht/Umgebung Junction/ambient	$R_{th JA}$	650	K/W
Sperrschicht/Löt看垫 Junction/solder point Montage auf PC-Board FR 4 (Padgröße $\geq 5 \text{ mm}^2$ ) mounted on PC board FR 4 (pad size $\geq 5 \text{ mm}^2$ )	$R_{th JS}$	370	K/W

<sup>1)</sup> für kurzzeitigen Betrieb geeignet / suitable for short term application

Kennwerte ( $T_A = 25\text{ °C}$ )

## Characteristics

Bezeichnung Parameter	Symbol Symbol	Wert Value	Einheit Unit
Farbkoordinate x nach CIE 1931 <sup>1)</sup> Chromaticity coordinate x acc. to CIE 1931 $I_F = 6\text{ mA}$	x	0.35	–
Farbkoordinate y nach CIE 1931 <sup>1)</sup> Chromaticity coordinate y acc. to CIE 1931 $I_F = 6\text{ mA}$	y	0.34	–
Abstrahlwinkel bei 50 % $I_V$ (Vollwinkel) (typ.) Viewing angle at 50 % $I_V$	$2\phi$	160	Grad deg.
Durchlassspannung <sup>2)</sup> (typ.) Forward voltage (max.) $I_F = 6\text{ mA}$	$V_F$ $V_F$	3.3 3.7	V V
Sperrstrom (typ.) Reverse current (max.) $V_R = 5\text{ V}$	$I_R$ $I_R$	0.01 10	$\mu\text{A}$ $\mu\text{A}$
Temperaturkoeffizient von $\lambda_{\text{peak}}$ (typ.) Temperature coefficient of $\lambda_{\text{peak}}$ $I_F = 6\text{ mA}; -10\text{ °C} \leq T \leq 100\text{ °C}$	$TC_x$	– 0.4	$10^{-3}/\text{K}$
Temperaturkoeffizient von $\lambda_{\text{dom}}$ (typ.) Temperature coefficient of $\lambda_{\text{dom}}$ $I_F = 6\text{ mA}; -10\text{ °C} \leq T \leq 100\text{ °C}$	$TC_y$	– 0.3	$10^{-3}/\text{K}$
Temperaturkoeffizient von $V_F$ (typ.) Temperature coefficient of $V_F$ $I_F = 6\text{ mA}; -10\text{ °C} \leq T \leq 100\text{ °C}$	$TC_V$	– 2.9	mV/K
Optischer Wirkungsgrad (typ.) Optical efficiency $I_F = 6\text{ mA}$	$\eta_{\text{opt}}$	4	lm/W

<sup>1)</sup> Farbortgruppen werden mit einer Stromeinprägungsdauer von 25 ms und einer Genauigkeit von  $\pm 0,01$  ermittelt.  
Chromaticity coordinate groups are tested at a current pulse duration of 25 ms and a tolerance of  $\pm 0.01$ .

<sup>2)</sup> Spannungswerte werden mit einer Stromeinprägungsdauer von 1 ms und einer Genauigkeit von  $\pm 0,1\text{ V}$  ermittelt.  
Voltages are tested at a current pulse duration of 1 ms and a tolerance of  $\pm 0.1\text{ V}$ .

<sup>1)</sup> **Farbortgruppen**  
**Chromaticity coordinate groups**

Gruppe Group	x		y	
	min.	max.	min.	max.
A2	0.290	0.350	0.250	0.410
B2	0.350	0.410	0.270	0.430

**Helligkeits-Gruppierungsschema**  
**Luminous Intensity Groups**

Lichtgruppe Luminous Intensity Group	Lichtstärke Luminous Intensity $I_v$ (mcd)
K	7.1 ...11.2
L	11.2 ...18.0
M	18.0 ...28.0

Helligkeitswerte werden mit einer Stromeinprägedauer von 25 ms und einer Genauigkeit von  $\pm 11\%$  ermittelt.  
 Luminous intensity is tested at a current pulse duration of 25 ms and a tolerance of  $\pm 11\%$ .

**Gruppenbezeichnung auf Etikett**  
**Group Name on Label**

Beispiel: K-A2

Example: K-A2

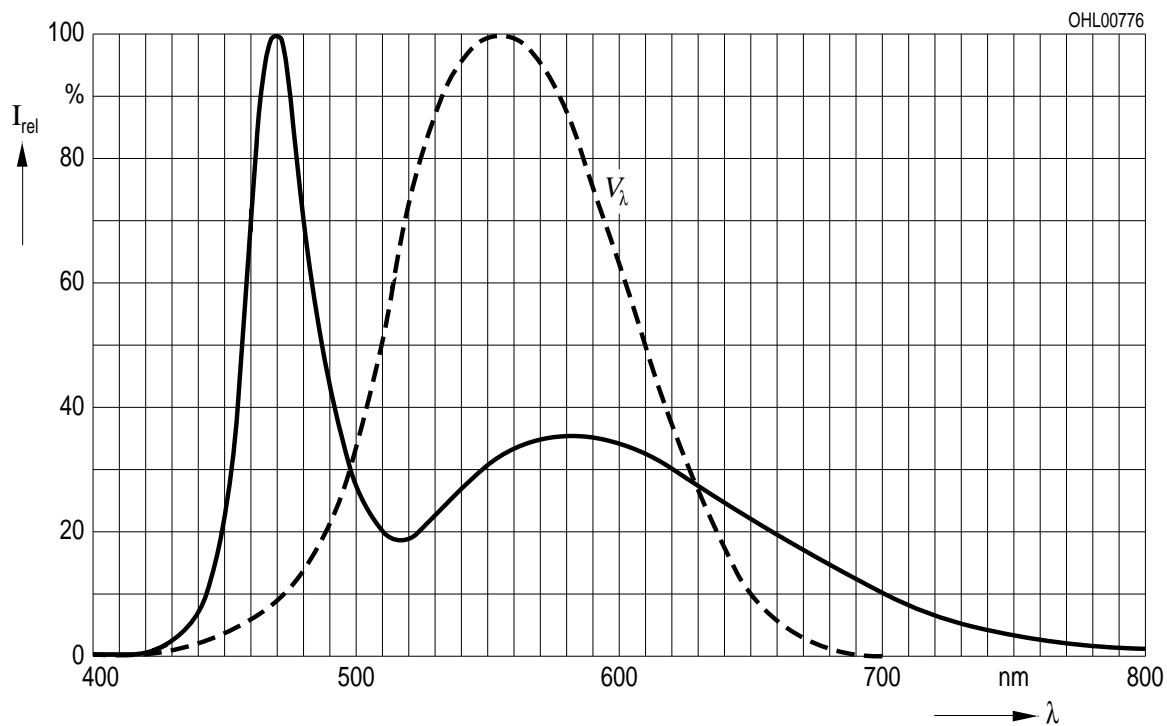
Lichtgruppe Luminous Intensity Group	Farbortgruppe Chromaticity Coordinate Group
K	A2

Relative spektrale Emission  $I_{rel} = f(\lambda)$ ,  $T_A = 25\text{ °C}$ ,  $I_F = 6\text{ mA}$

**Relative Spectral Emission**

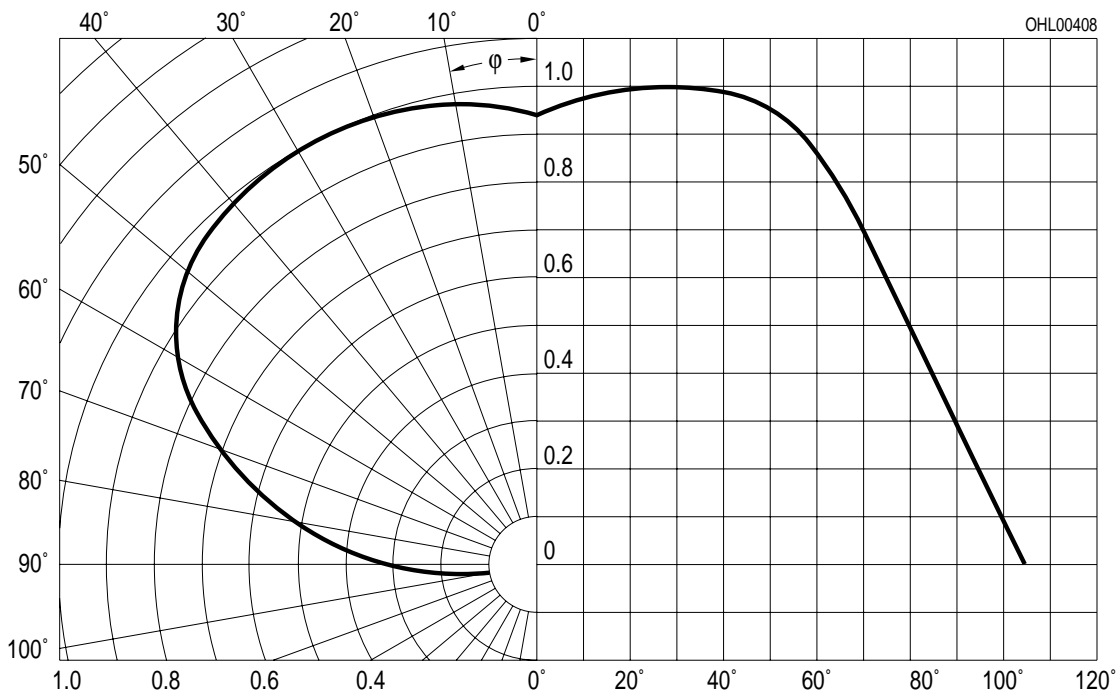
$V(\lambda)$  = spektrale Augenempfindlichkeit

Standard eye response curve



Abstrahlcharakteristik  $I_{rel} = f(\varphi)$

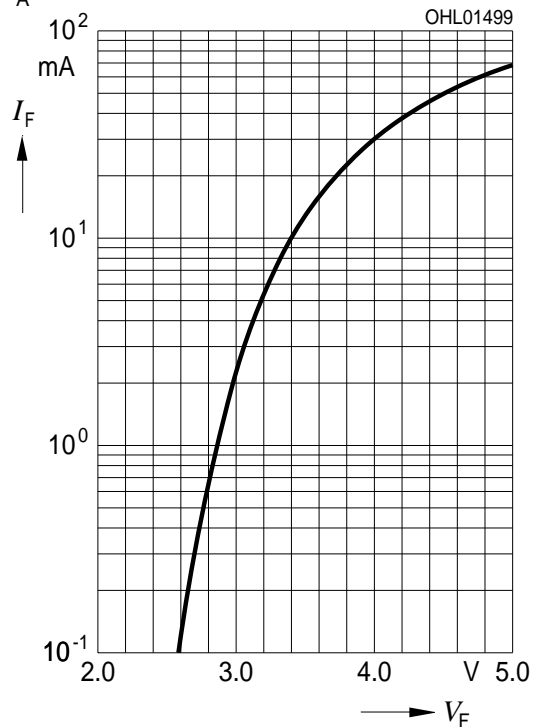
**Radiation Characteristic**



**Durchlassstrom  $I_F = f(V_F)$**

**Forward Current**

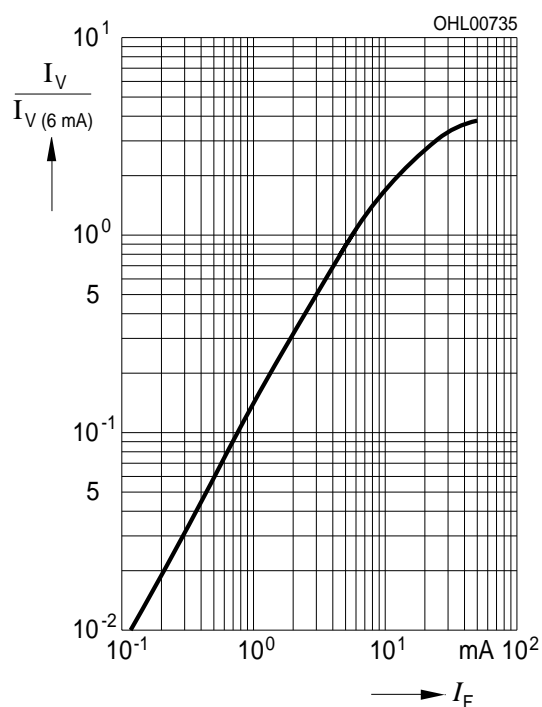
$T_A = 25\text{ °C}$



**Relative Lichtstärke  $I_V/I_{V(6\text{ mA})} = f(I_F)$**

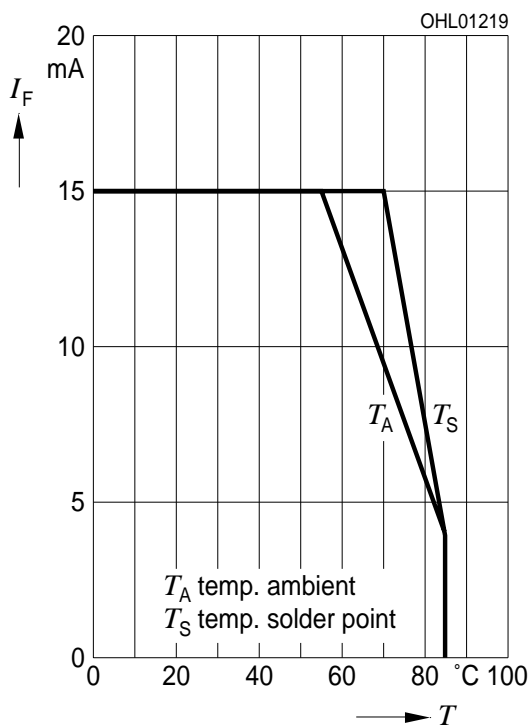
**Relative Luminous Intensity**

$T_A = 25\text{ °C}$



**Maximal zulässiger Durchlassstrom  $I_F = f(T)$**

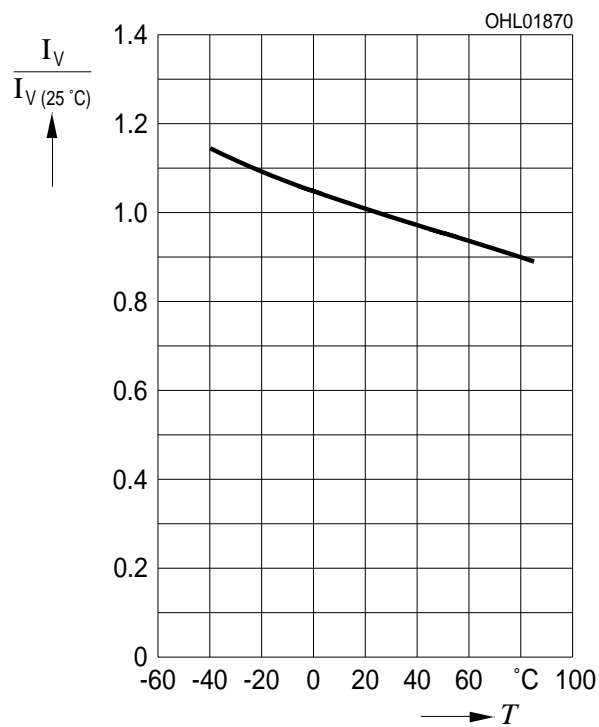
**Max. Permissible Forward Current**



**Relative Lichtstärke  $I_V/I_{V(25\text{ °C})} = f(T_A)$**

**Relative Luminous Intensity**

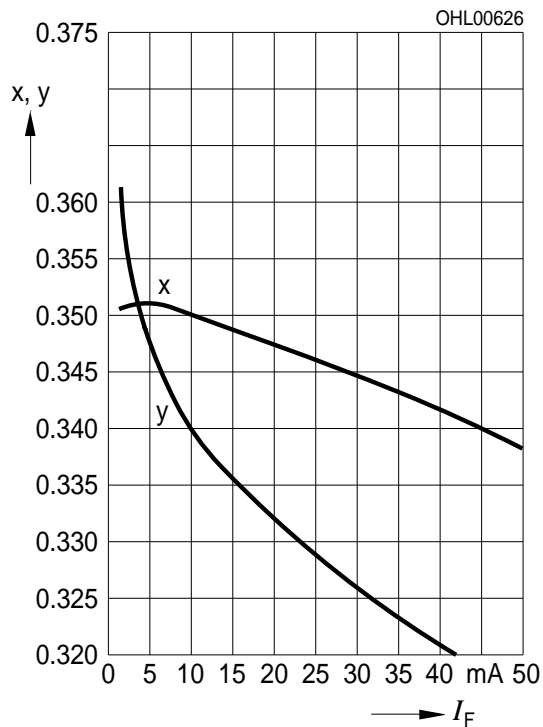
$I_F = 6\text{ mA}$



**Farbortverschiebung  $x, y = f(T)$**

**Chromacity Coordinate Shift**

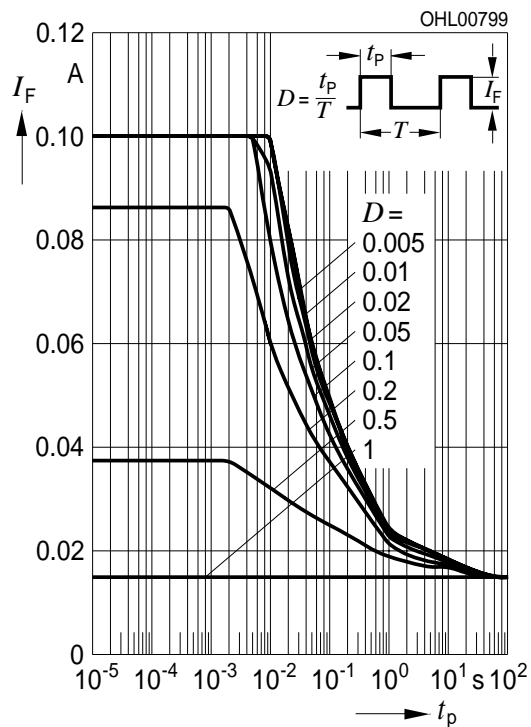
$T_A = 25\text{ °C}$



**Zulässige Impulsbelastbarkeit  $I_F = f(t_p)$**

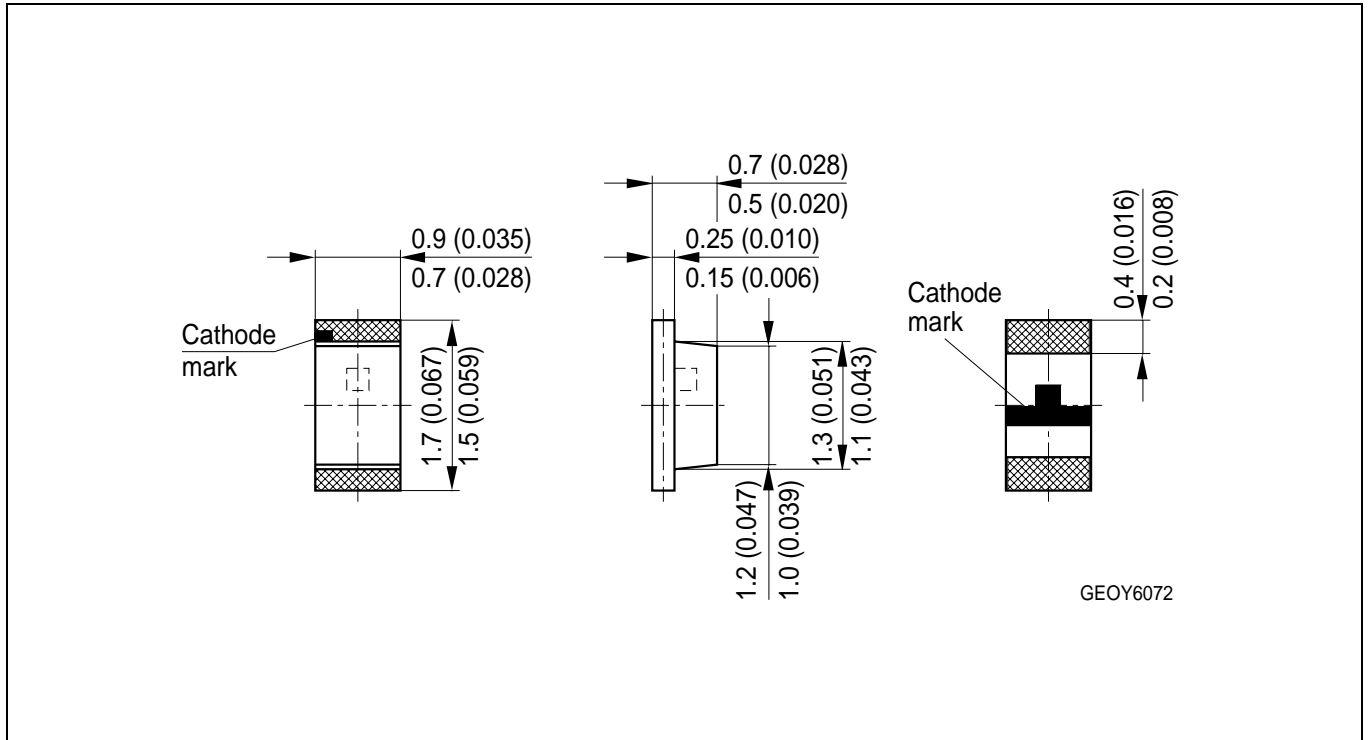
**Permissible Pulse Handling Capability**

Duty cycle  $D =$  parameter,  $T_A = 25\text{ °C}$





**Maßzeichnung**  
**Package Outlines**

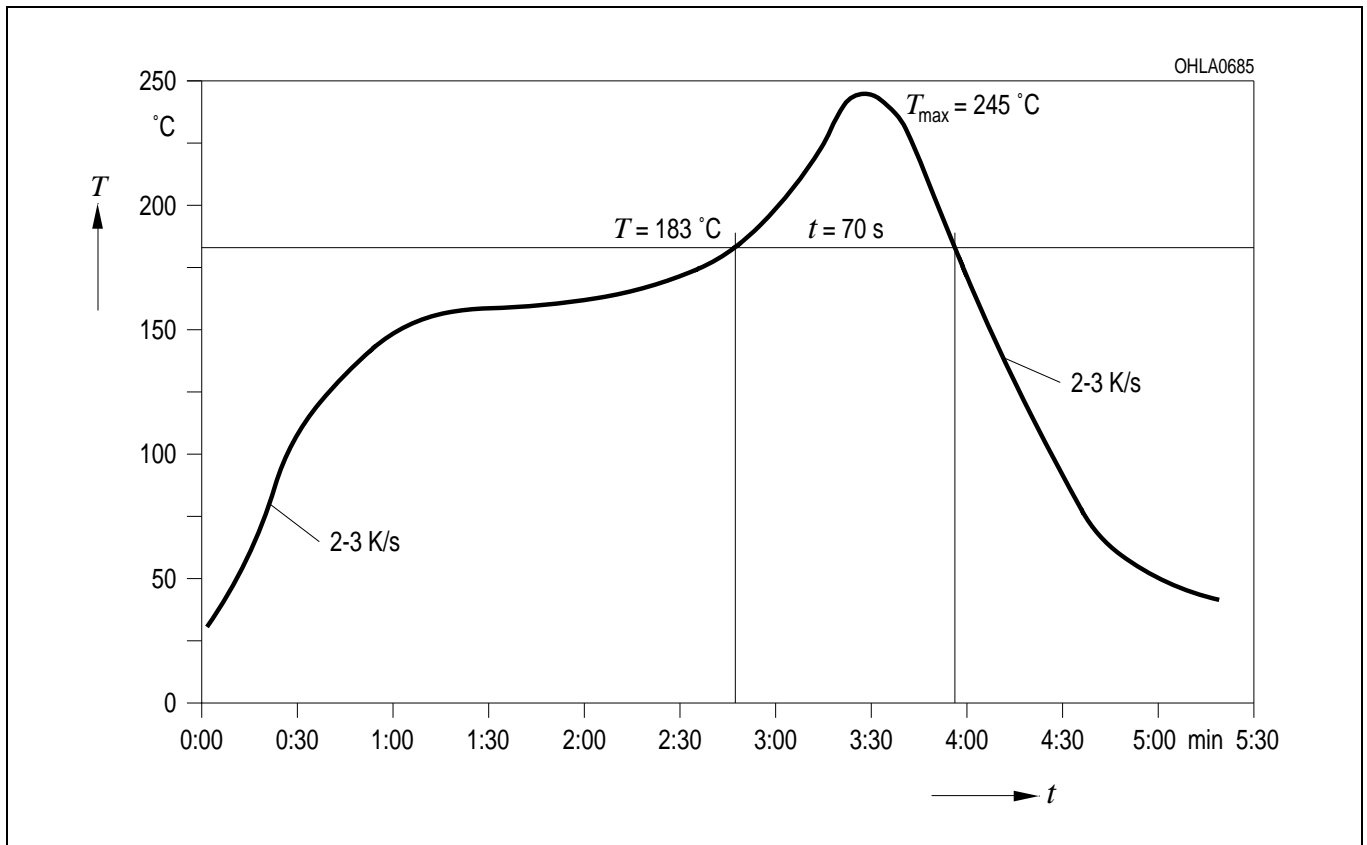


Maße werden wie folgt angegeben: mm (inch) / Dimensions are specified as follows: mm (inch).

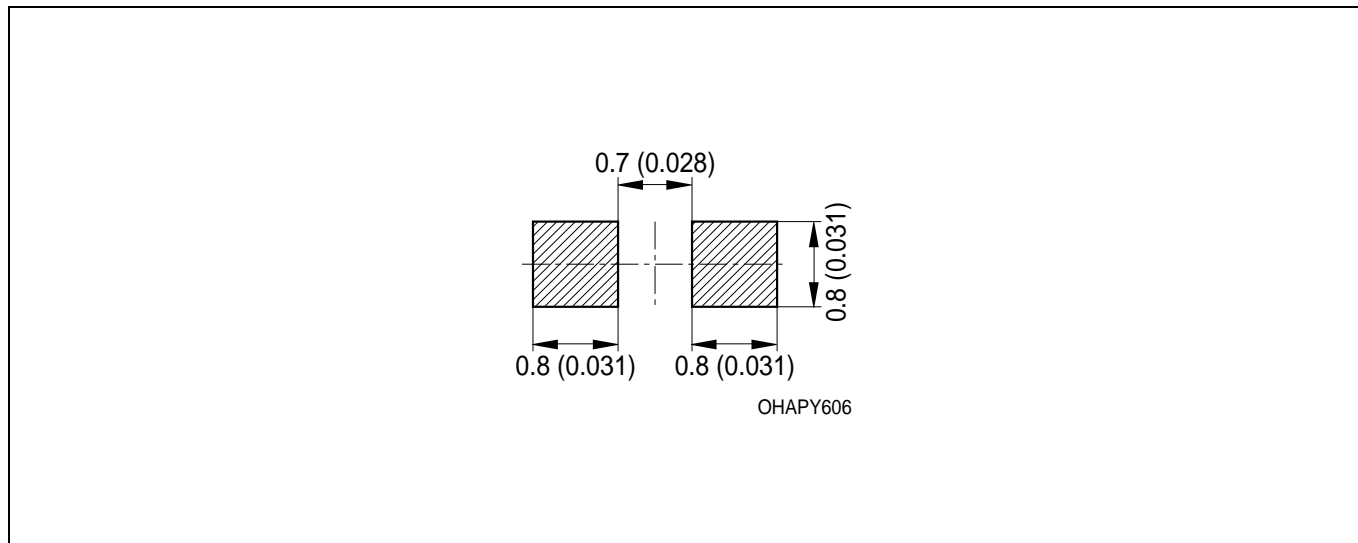
**Gewicht / Approx. weight:** 1.4 mg

**Lötbedingungen** Vorbehandlung nach JEDEC Level 2  
**Soldering Conditions** Preconditioning acc. to JEDEC Level 2

**IR-Reflow Lötprofil** (nach IPC 9501)  
**IR Reflow Soldering Profile** (acc. to IPC 9501)



**Empfohlenes Lötpad Design** IR Reflow Löten  
**Recommended Solder Pad** IR Reflow Soldering



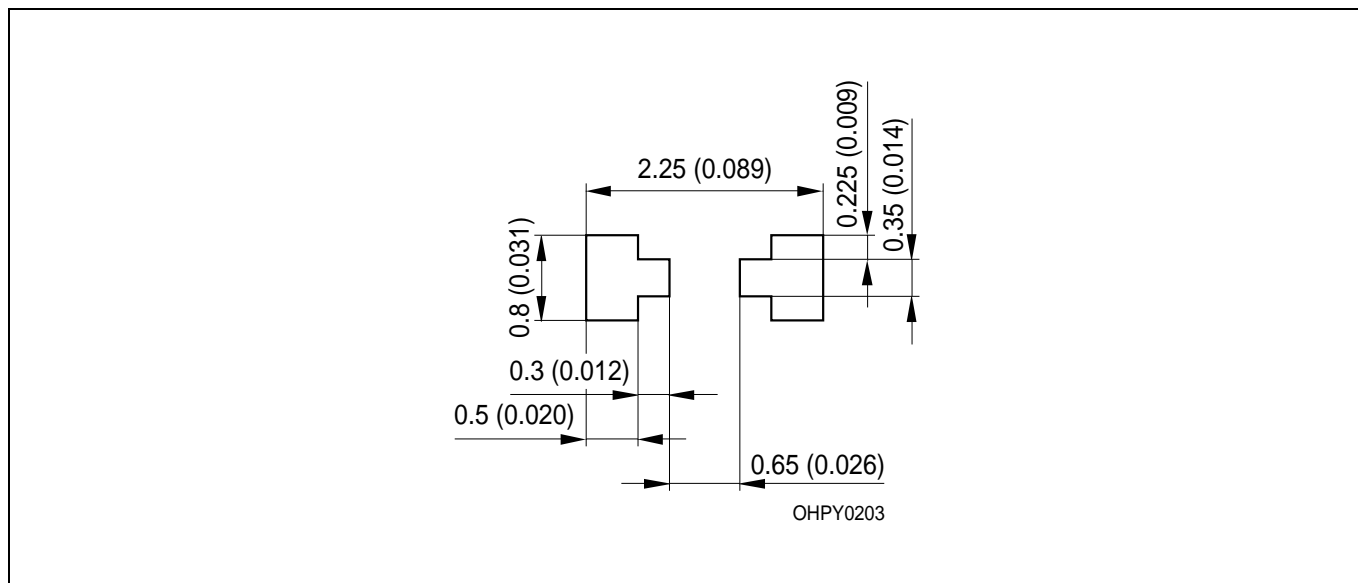
Maße werden wie folgt angegeben: mm (inch) / Dimensions are specified as follows: mm (inch).

**Empfohlenes Lötpad Design verwendbar für Chiplid - Bauform 0603 und SmartLED™**

IR Reflow Löten

**Recommended Solder Pad useable for Chiplid - Package 0603 and SmartLED™**

IR Reflow Soldering



Maße werden wie folgt angegeben: mm (inch) / Dimensions are specified as follows: mm (inch).  
 Empfohlene Lötpastendicke: 120 µm / recommended thickness of solder paste: 120 µm



Revision History: 2003-02-18		Date of change
Previous Version: 2003-02-17		
Page	Subjects (major changes since last revision)	
2	$I_F$ reduced from 10 mA to 6 mA	
11	recommended solder pad	
4	forward voltage	
7	diagram relative luminous intensity OHL00870 to OHL01870	
8	diagram chromacity coordinate shift	
3	pad size from 16 mm <sup>2</sup> to 5 mm <sup>2</sup>	
5	change group name of chromaticity coordinate groups	
8	Permissible Pulse Handling Capability	2002-07-22
13	annotations	2002-07-25
3	reverse voltage (footnote)	2002-08-21
2	wavelength groups	2002-09-19

### Patent List

#### Patent No.

US 6 066 861, US 6 277 301

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